

COPY

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COMBINED DECLARATION AND POWER OF ATTORNEY
Original United States Patent Application

As a below named inventor I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

COLLAR DIELECTRIC PROCESS FOR REDUCING A TOP WIDTH OF A DEEP TRENCH

IDENTIFICATION OF SPECIFICATION:

The specification of which is attached hereto unless the following item is checked:

— was filed on _____ as United States Application Serial Number _____ and was amended on _____ (if applicable).

ACKNOWLEDGEMENT OF REVIEW OF PAPERS AND DUTY OF CANDOR:

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, §1.56, including, for continuation-in-part applications, material information which became available between the filing date of the prior application and the continuation-in-part application.

FOREIGN PRIORITY CLAIM:

I hereby claim foreign priority benefits under Title 35, United States Code, §119(a)-(d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application(s) for patent or inventor's certificate having a filing date before that of the application on which priority is claimed.

APPLICATION NUMBER	COUNTRY	DATE OF FILING (day, month, year)	Certified Copy Attached
92108222	Taiwan, R.O.C.	10 April 2003	<input checked="" type="checkbox"/>
			<input type="checkbox"/>
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			<input type="checkbox"/>

— Additional foreign application(s) are listed on a supplementary priority data sheet attached hereto.

FOREIGN APPLICATIONS FILED MORE THAN 12 MONTHS PRIOR TO THIS U.S. APPLICATION:

APPLICATION NUMBER	COUNTRY	DATE OF FILING (day, month, year)

— Additional foreign application(s) filed more than 12 months prior to this U.S. application are listed on a supplementary foreign application sheet attached hereto.

POWER OF ATTORNEY:

As named inventor, I hereby appoint the following attorney(s) and/or patent agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

Nelson A. Quintero, #52,143, of the firm Quintero Law Office

I hereby authorize them to act and rely on instructions from and communicate directly with the person/assignee/attorney/firm/organization who/which first sends/sent this case to them and by whom/which I hereby declare that I have consented after full disclosure to be represented unless/until I instruct Quintero Law Office to the contrary.

Please direct all correspondence to:

Nelson A. Quintero, Esq.
Quintero Law Office
1617 Broadway, 3rd Floor
Santa Monica, California 90404

Please direct telephone calls to:

Nelson A. Quintero
1-310-401-6180

DECLARATION:

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

SIGNATURE(S):

Full Name Of Inventor 1	Family Name HSU	First Given Name Ping	Second Given Name
Residence & Citizenship	City Taipei	State or Foreign Country Taiwan, R.O.C.	Country of Citizenship Taiwan, R.O.C.
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Signature of Inventor 1: <i>Ding Hsu</i>		Date: July 21, 2003	